

DESCRIPTION

The MBD7000L is available in SOT-23 package.

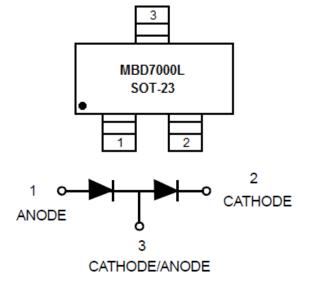
FEATURES

• Available in SOT-23 package

ORDERING INFORMATION

PIN DESCRIPTION

Package Type	Part Number		
SOT-23	MBD7000L		
Note	3,000pcs/Reel		
AiT provides all RoHS Compliant Products			





ABSOLUTE MAXIMUM RATINGS

EACH DIODE

V _R , Reverse Voltage	100Vdc
I _F , Forward Current	200mAdc
I _{FM(surge)} , Peak Forward Surge Current	500mAdc

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Unit
Total Device Dissipation FR– 5 Board, NOTE1			
$T_A = 25^{\circ}C$	PD	225	mW
Derate above 25°C		1.8	mW/°C
Thermal Resistance, Junction to Ambient	R _{0JA}	556	°C/W
Total Device Dissipation Alumina Substrate ^{NOTE2}			
$T_A = 25^{\circ}C$	PD	300	mW
Derate above 25°C		2.4	mW/°C
Thermal Resistance, Junction to Ambient	R _{0JA}	417	°C/W
Junction and Storage Temperature	TJ, Tstg	-55 to +150	°C

NOTE1: FR-5 = 1.0 x 0.75 x 0.062 in.

NOTE2: Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.



ELECTRICAL CHARACTERISTICS

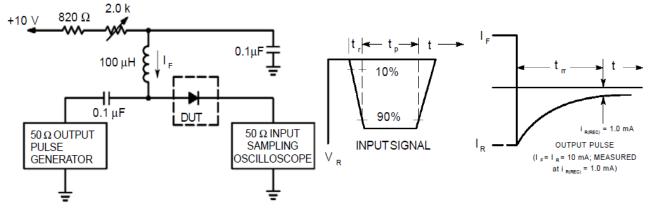
Parameter	Symbol	Characteristic	Min	Max	Unit	
OFF CHARACTERISTICS						
Reverse Breakdown Voltage	V _(BR)	I _(BR) = 100µAdc	100	-	Vdc	
Reverse Voltage Leakage Current	IR	V _R = 50Vdc	-	1.0	µAdc	
	I _{R2}	V _R = 100Vdc		3.0		
	I _{R3}	V _R = 50Vdc, 125°C		100		
Forward Voltage	VF	I _F = 1.0mAdc	0.55 0.7			
		I _F = 10mAdc	0.67	0.82	.82 Vdc	
		I _F = 100mAdc	0.75	1.1		
Reverse Recovery Time	trr	$I_F = I_R = 10 \text{mAdc} (Figure.1)$	-	4.0	Vdc	
Capacitance	С	V _R = 0V	-	1.5	Vdc	

 $T_A = 25^{\circ}C$ unless otherwise noted. (EACH DIODE)

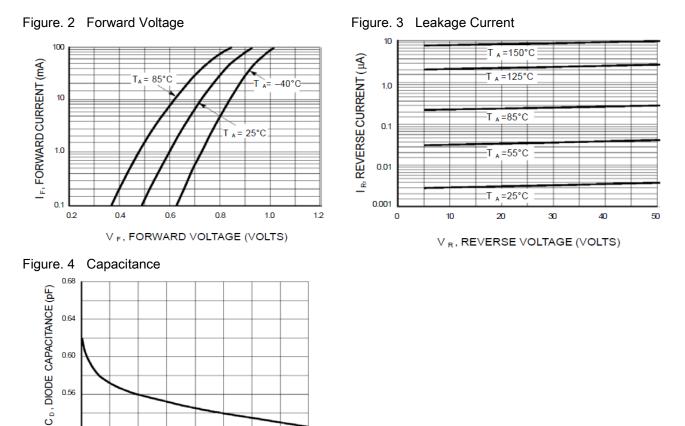


TYPICAL PERFORMANCE CHARACTERISTICS





NOTE1: A 2.0kΩ variable resistor adjusted for a Forward Current (I_F) of 10mA. NOTE2: Input pulse is adjusted so $I_{R(peak)}$ is equal to 10mA. NOTE3: t p » trr



4.0

V_R, REVERSE VOLTAGE (VOLTS)

6.0

8.0

2.0

0.60

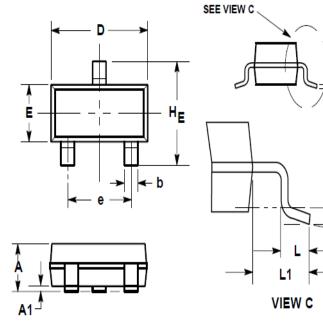
0.56

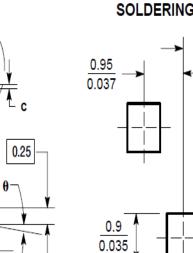
0.52 0



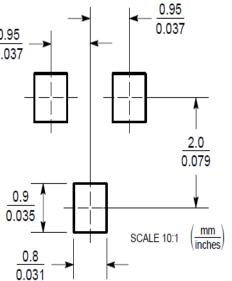
PACKAGE INFORMATION

Dimension in SOT-23 Package (Unit: mm)





SOLDERING FOOTPRINT



DIM	INCHES		MILLIMETERS		
	MIN	MAX	MIN	MAX	
А	0.035	0.044	0.89	1.11	
A1	0.001	0.004	0.01	0.10	
b	0.015	0.020	0.37	0.50	
с	0.003	0.007	0.09	0.18	
D	0.110	0.120	2.80	3.04	
E	0.047	0.055	1.20	1.40	
е	0.070	0.081	1.78	2.04	
L	0.004	0.012	0.10	0.30	
L1	0.014	0.029	0.35	0.69	
HE	0.083	0.104	2.10	2.64	



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